

WMM7027ATHD1

Top port analog silicon Microphone

Descriptions

The WMM7027ATHD1 is a miniature, high performance, low power, top port silicon microphone. The WMM7027ATHD1 consists of an acoustic sensor, a low noise input buffer, and an output amplifier. These devices are suitable for protable electronic devices where excellent wideband audio performance and RF immunity are required applications.

The WMM7027ATHD1 is manufactured in a compact 2.75mm*1.85mm*0.95mm, 4-pin package.

Features

- Small package
- Low current
- Flat Frequency Response
- High SNR
- Ultra-Stable Performance
- Standard SMD Reflow
- Omnidirectional

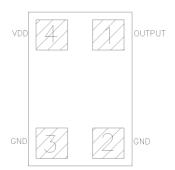
Applications

- Cellphones
- Smart phones
- ANC-TWS/Headset
- Digital still cameras
- Portable music recorders

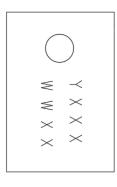
Http//:www.willsemi.com



Product appearance



Pin configuration (Bottom view)



Marking (Top view)

Y = Year code

WW = Week code

X X X

X X = Batch code

Order information

Device	Package	Shipping
WMM7027ATHD1-4/TR	2.75*1.85*0.95	5000/Reel&Tape



Absolute maximum ratings

Parameter	Absolute Maximum Rating	Units
VDD to Ground	-0.5, +5.0	V
OUT to Ground	-0.3, VDD + 0.3	V
Input Current to Any Pin	±5	mA
Temperature Range	-40 to +100	°C

Stresses exceeding these "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only. Functional operation at these or any other conditions beyond those indicated under "Acoustic & Electrical Specifications" is not implied. Exposure beyond those indicated under "Acoustic & Electrical Specifications" for extended periods may affect device reliability.

ACOUSTIC & ELECTRICAL SPECIFICATIONS

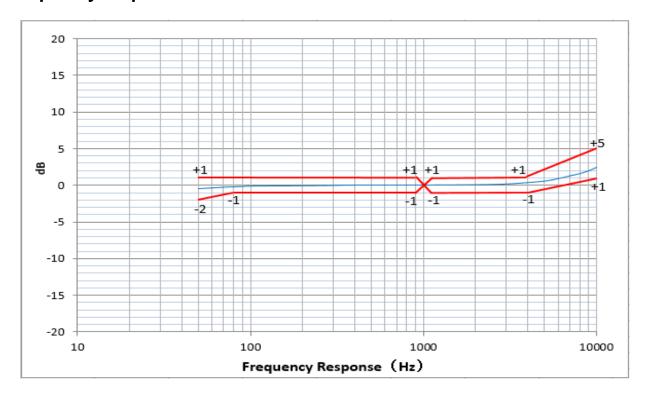
TEST CONDITIONS: 23 ±2°C, 55±20% R.H., VDD(min) < VDD < VDD(max), no load, unless otherwise indicated.

Parameter	Symbol	Conditions	Min	Тур	Max	Units
Supply Voltage	VDD		1.5	-	3.6	V
Supply Current	IDD		-	146	-	uA
Sensitivity	S	94dB SPL @1KHz	-39	-38	-37	dBv
Signal to Noise Ratio	SNR	94dB SPL @1KHz, A-weighted	-	65	-	dB(A)
Total Harmonic Distortion	THD	94dB SPL @1KHz, S=Typ	-	0.15	-	%
Acoustic Overload Point	AOP	10%THD @1KHz, S=Typ	-	130	-	dBSPL
Power Supply Rejection	PSR	100mVpp 7/8 duty cycle rectangular wave @217Hz, A-weight, 20KHz BW	-	-90	-	dBv
Power Supply Rejection Ratio	PSRR	200mVpp sinewave@ 1 kHz	ı	65	-	dB
		50Hz~100Hz @ 94dB SPL	-3	-	3	
Phase	θ	100Hz~5kHz @ 94dB SPL	-1	-	1	0
		5KHz~10kHz @ 94dB SPL	-5	-	5	
DC Output		-	-	0.6	-	V
Output impedance	ZOUT	@1KH	-	100	-	Ω
Directivity				Omnid	lirection	nal

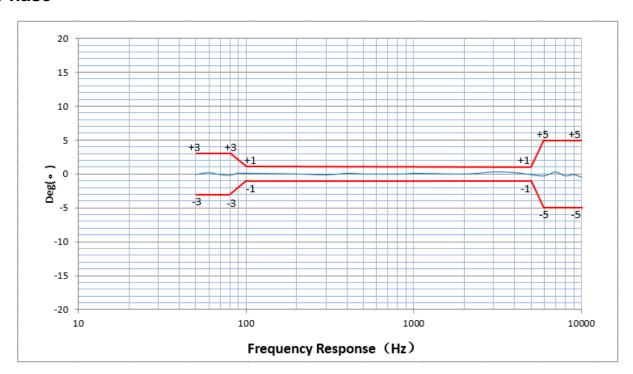
Typical specifications are measured at VDD = 2.2V.



Frequency response curve

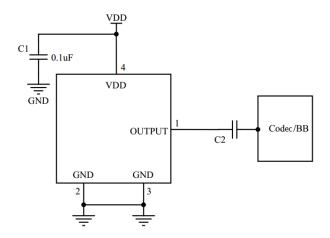


Phase





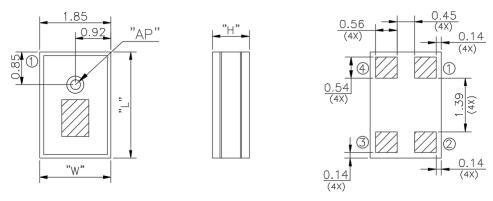
Application informations



Note:

- All GND pins must be connected to ground.
- Capacitors near the microphone should not contain Class 2 dielectrics.

MECHANICAL SPECIFICATIONS



Item	Dimension	Tolerance
Length(L)	2.75	±0.10
Width(W)	1.85	±0.10
Height(H)	0.95	±0.10
Acoustic Port (AP)	Ø0.25	±0.05

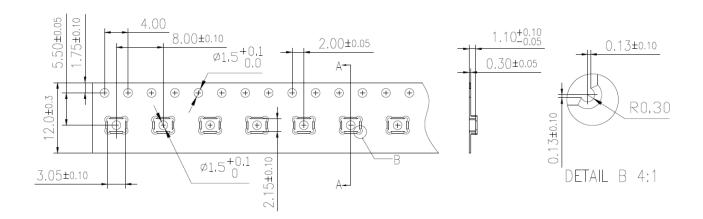
Pin#	Pin Name	Description
1	OUTPUT	Output Signal
2	GND	GND
3	GND	GND
4	VDD	Power Supply

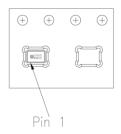
Notes:

- Dimensions are in millimeters unless otherwise specified.
- Tolerance is ±0.10mm unless otherwise specified.



PACKAGING & MARKING DETAIL





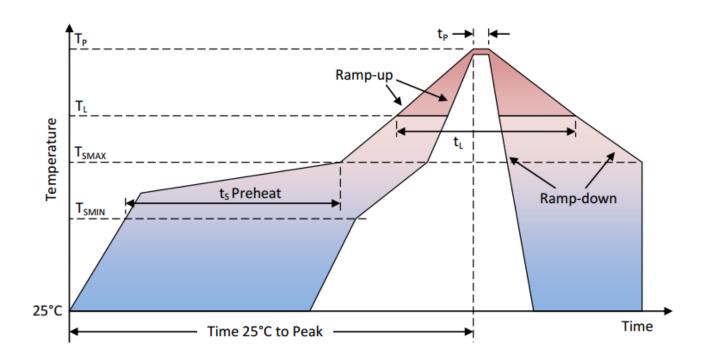
Model Number	Reel Diameter	Quantity Per Reel
WMM7027ATHD1	13"	5,000

Notes:

- Dimensions are in millimeters unless otherwise specified.
- Vacuum pickup only in the pick area indicated in Mechanical Specifications.
- Tape & reel per EIA-481.
- Labels applied directly to reel and external package.



REFERENCED REFLOW PROFILE



Profile Feature	Pb-Free
Average Ramp-up rate (Tsmax to Tp)	3°C/second max.
Preheat Temperature Min (Tsmin) Temperature Max (Tsmax) Time (Tsmin to Tsmax) (ts)	150°C 200°C 60-180 seconds
Time maintained above: • Temperature (TL) • Time (tL)	217°C 60-150 seconds
Peak Temperature (T _P)	260°C
Time within 5°C of actual Peak Temperature (tp)	20-40 seconds
Ramp-down rate (TP to TSMAX)	6°C/second max
Time 25°C to Peak Temperature	8 minutes max

Note

All temperatures refer to topside of the package, measured on the package body surface.



ADDITIONAL NOTES

- (A) Maximum of 3 reflow cycles is recommended.
- (B) In order to minimize device damage:
 - Do not board wash or clean after the reflow process.
 - Do not brush board with or without solvents after the reflow process.
 - Do not directly expose to ultrasonic processing, welding, or cleaning.
 - Do not insert any object in port hole of device at any time.
 - Do not apply over 30 psi of air pressure into the port hole.
 - Do not pull a vacuum over port hole of the microphone.
- Do not apply a vacuum when repacking into sealed bags at a rate faster than 0.5 atm/sec.

MATERIALS STATEMENT

Meets the requirements of the European RoHS and Halogen-Free.

RELIABILITY SPECIFICATIONS

to-air thermal shock from -40°C to +125°C with 15 minute +105°C environment
1105°C anvironment
+1115 1 600000000000
-40°C environment
+105°C under bias.
-40°C under bias.
+85°C /85% R.H.
to 2,000 Hz sinusoidal sweep with 20g peak acceleration
utes in X, Y, and Z directions.
f ±2 kV direct contact to I/O pins.
f ±8 kV direct contact to lid while unit is grounded.
f ±200V direct contact to I/O pins.
s with peak temperature of +260°C
00g in the X, Y, and Z direction
ference in operation after dropped to marble or 1.0cm times from 1.5 meter height.

Note:

After reliability tests are performed, the sensitivity of the microphones shall not deviate more than 1 dB from its initial value.